

# Precision, 20 MHz, CMOS, Rail-to-Rail Input/Output Operational Amplifiers

# AD8615/AD8616/AD8618

#### **FEATURES**

Low offset voltage: 65 µV max Single-supply operation: 2.7 V to 5.5 V Low noise: 8 nV/√Hz Wide bandwidth: >20 MHz Slew rate: 12 V/µs High output current: 150 mA No phase reversal Low input bias current: 1 pA Low supply current: 2 mA Unity-gain stable

### **APPLICATIONS**

Rev. C

Barcode scanners Battery-powered instrumentation Multipole filters Sensors ASIC input or output amplifier Audio Photodiode amplification GENERAL DESCRIPTION

The AD8615/AD8616/AD8618 are dual/quad, rail-to-rail, input and output, single-supply amplifiers featuring very low offset voltage, wide signal bandwidth, and low input voltage and current noise. The parts use a patented trimming technique that achieves superior precision without laser trimming. The AD8615/AD8616/AD8618 are fully specified to operate from 2.7 V to 5 V single supplies.

The combination of 20 MHz bandwidth, low offset, low noise, and very low input bias current make these amplifiers useful in a wide variety of applications. Filters, integrators, photodiode amplifiers, and high impedance sensors all benefit from the combination of performance features. AC applications benefit from the wide bandwidth and low distortion. The AD8615/AD8616/AD8618 offer the highest output drive capability of the DigiTrim<sup>™</sup> family, which is excellent for audio line drivers and other low impedance applications.

Applications for the parts include portable and low powered instrumentation, audio amplification for portable devices, portable phone headsets, bar code scanners, and multipole filters. The ability to swing rail-to-rail at both the input and output enables designers to buffer CMOS ADCs, DACs, ASICs, and other wide output swing devices in single-supply systems.

The AD8615/AD8616/AD8618 are specified over the extended industrial (-40°C to +125°C) temperature range. The AD8615 is available in 5-lead TSOT-23 packages. The AD8616 is available in 8-lead MSOP and narrow SOIC surface-mount packages; the MSOP version is available in tape and reel only. The AD8618 is available in 14-lead SOIC and TSSOP packages.



#### **PIN CONFIGURATIONS**

OUT A 1 -IN A 4 +IN A 4 V+ -IN B 4 -IN B 7 OUT B 7	14 AD8618 8	OUT D -IN D +IN D V- +IN C -IN C OUT C	04648-0-048

Figure 4. 14-Lead TSSOP (RU-14)



Figure 5. 14-Lead SOIC (R-14)

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### 1/05—Rev. A to Rev. B

Added AD8615	.Universal
Changes to Figure 12	8
Deleted Figure 19; Renumbered Subsequent Figures	s 8
Changes to Figure 20	9
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Changes to Figure 31	11
Deleted Figure 34; Renumbered Subsequent Figures	s 11
Deleted Figure 35; Renumbered Subsequent Figures	s 35

#### 4/04—Rev. 0 to Rev. A

Added AD8618	Universal
Updated Outline Dimensions	

#### 1/04—Revision 0: Initial Version

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## **SPECIFICATIONS**

 $V_s$  =5 V,  $V_{CM}$  =  $V_s/2$ ,  $T_A$  = 25°C, unless otherwise noted.

### Table 1.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage AD8616/AD8618/ AD8615	Vos	$V_{\text{S}}$ = 3.5 V at $V_{\text{CM}}$ = 0.5 V and 3.0 V		23 23	60 100	μV μV
		$V_{CM} = 0 V$ to 5 V		80	500	μV
		-40°C < T <sub>A</sub> < +125°C			800	μV
Offset Voltage Drift AD8616/AD8618/ AD8615	$\Delta V_{os}/\Delta T$	-40°C < T <sub>A</sub> < +125°C		1.5 3	7 10	μV/°C μV/°C
Input Bias Current	IB			0.2	1	pА
		$-40^{\circ}C < T_{A} < +85^{\circ}C$			50	pA
		$-40^{\circ}C < T_{A} < +125^{\circ}C$			550	pА
Input Offset Current	los			0.1	0.5	рА
		$-40^{\circ}C < T_A < +85^{\circ}C$			50	рА
		$-40^{\circ}C < T_A < +125^{\circ}C$			250	pА
Input Voltage Range			0		5	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = 0 V \text{ to } 4.5 V$	80	100		dB
Large Signal Voltage Gain	Avo	$R_L=2~k\Omega,V_O=0.5~V$ to $5~V$	105	1500		V/mV
Input Capacitance	CDIFF			2.5		pF
	Ссм			6.7		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	Vон	I∟ = 1 mA	4.98	4.99		V
		I <sub>L</sub> = 10 mA	4.88	4.92		V
		$-40^{\circ}C < T_A < +125^{\circ}C$	4.7			V
Output Voltage Low	Vol	$I_L = 1 \text{ mA}$		7.5	15	mV
		$I_L = 10 \text{ mA}$		70	100	mV
		$-40^{\circ}C < T_A < +125^{\circ}C$			200	mV
Output Current	Іоυт			±150		mA
Closed-Loop Output Impedance	Zout	$f = 1 MHz, A_V = 1$		3		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	$V_{s} = 2.7 V \text{ to } 5.5 V$	70	90		dB
Supply Current per Amplifier	Isy	$V_{O} = 0 V$		1.7	2.0	mA
		$-40^{\circ}C < T_A < +125^{\circ}C$			2.5	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 2 \ k\Omega$		12		V/µs
Settling Time	ts	To 0.01%		<0.5		μs
Gain Bandwidth Product	GBP			24		MHz
Phase Margin	Øm			63		Degrees
NOISE PERFORMANCE						
Peak-to-Peak Noise	en p-p	0.1 Hz to 10 Hz		2.4		μV
Voltage Noise Density	en	f = 1 kHz		10		nV/√Hz
		f = 10 kHz		7		nV/√Hz
Current Noise Density	İn	f = 1 kHz		0.05		pA/√Hz
Channel Separation	Cs	f = 10 kHz		-115		dB
		f = 100 kHz		-110		dB

$V_{s} = 2.7 V, V_{CM}$	$_{4} = V_{s}/2, T_{A} =$	25°C, unless	otherwise noted.
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# Table 2.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage AD8616/AD8618/ AD8615	V <sub>os</sub>	$V_{\text{S}}$ = 3.5 V at $V_{\text{CM}}$ = 0.5 V and 3.0 V		23 23	65 100	μV
AD6015		$V_{CM} = 0 V$ to 2.7 V		25 80	500	μV
		$-40^{\circ}C < T_{A} < +125^{\circ}C$		80	800	μV μV
Offerst Visite as Drift AD9616 (AD9619)	A)/ /AT			1 5		
Offset Voltage Drift AD8616/AD8618/ AD8615	ΔV <sub>os</sub> /ΔT	-40°C < T <sub>A</sub> < +125°C		1.5 3	7 10	μV/°C μV/°C
Input Bias Current	IB			0.2	1	рА
		$-40^{\circ}C < T_{A} < +85^{\circ}C$			50	рА
		$-40^{\circ}C < T_{A} < +125^{\circ}C$			550	рА
Input Offset Current	l <sub>os</sub>			0.1	0.5	pА
		$-40^{\circ}C < T_{A} < +85^{\circ}C$			50	рА
		$-40^{\circ}C < T_A < +125^{\circ}C$			250	рА
Input Voltage Range			0		2.7	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = 0 V$ to 2.7 V	80	100		dB
Large Signal Voltage Gain	Avo	$R_L$ = 2 kΩ, $V_O$ = 0.5 V to 2.2 V	55	150		V/mV
Input Capacitance	CDIFF			2.5		рF
-	Ссм			7.8		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	Vон	I∟ = 1 mA	2.65	2.68		V
		-40°C < T <sub>A</sub> < +125°C	2.6			v
Output Voltage Low	Vol	$I_L = 1 \text{ mA}$		11	25	mV
1 5		-40°C < T <sub>A</sub> < +125°C			30	mV
Output Current	Ιουτ			±50		mA
Closed-Loop Output Impedance	Zout	$f = 1 MHz, A_v = 1$		3		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	$V_{s} = 2.7 V \text{ to } 5.5 V$	70	90		dB
Supply Current per Amplifier	Isy	$V_0 = 0 V$		1.7	2	mA
		-40°C < T <sub>A</sub> < +125°C			2.5	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 2 \ k\Omega$		12		V/µs
Settling Time	ts	To 0.01%		< 0.3		μs
Gain Bandwidth Product	GBP			23		MHz
Phase Margin	Øm			42		Degree
NOISE PERFORMANCE		1				
Peak-to-Peak Noise	en p-p	0.1 Hz to 10 Hz		2.1		μV
Voltage Noise Density	en en	f = 1  kHz		10		nV/√Hz
		f = 10  kHz		7		nV/√Hz
Current Noise Density	İn	f = 1  kHz		0.05		pA/√Hz
Channel Separation	Cs	f = 10  kHz		-115		dB
		f = 100  kHz		-110		dB

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 3.

Parameter	Rating
Supply Voltage	6V
Input Voltage	GND to Vs
Differential Input Voltage	±3V
Output Short-Circuit Duration to GND	Indefinite
Storage Temperature	–65°C to +150°C
Operating Temperature Range	–40°C to +125°C
Lead Temperature Range (Soldering 60 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for the worst-case conditions, that is,  $\theta_{JA}$  is specified for device soldered in circuit board for surface-mount packages.

### Table 4.

Package Type	θ」Α	θıc	Unit
5–Lead TSOT-23 (UJ)	207	61	°C/W
8-Lead MSOP (RM)	210	45	°C/W
8-Lead SOIC (R)	158	43	°C/W
14-Lead SOIC (R)	120	36	°C/W
14-Lead TSSOP (RU)	180	35	°C/W



### **TYPICAL PERFORMANCE CHARACTERISTICS**



Figure 6. Input Offset Voltage Distribution

04648-0-003











Figure 9. Input Bias Current vs. Temperature



Figure 10. Output Voltage to Supply Rail vs. Load Current



Figure 11. Output Saturation Voltage vs. Temperature

04648-0-008



Figure 12. Open-Loop Gain and Phase vs. Frequency



Figure 13. Closed-Loop Output Voltage Swing



Figure 14. Output Impedance vs. Frequency



Figure 15. Common-Mode Rejection Ratio vs. Frequency



Figure 16. PSRR vs. Frequency



Figure 17. Small-Signal Overshoot vs. Load Capacitance

04648-0-012



Figure 18. Supply Current vs. Temperature



Figure 19. Supply Current vs. Supply Voltage



Figure 20. Voltage Noise Density vs. Frequency













04648-0-019





04648-0-025

04648-0-026

Figure 27. Input Offset Voltage vs. Common-Mode Voltage (200 Units, Five Wafer Lots Including Process Skews)



Figure 28. Input Offset Voltage vs. Common-Mode Voltage (200 Units, Five Wafer Lots Including Process Skews)



Figure 29. Output Voltage to Supply Rail vs. Load Current





Figure 25. 0.1 Hz to 10 Hz Input Voltage Noise



Figure 26. Input Offset Voltage Distribution

04648-0-024



Figure 30. Output Saturation Voltage vs. Temperature







Figure 32. Closed-Loop Output Voltage Swing vs. Frequency



Figure 33. Small-Signal Overshoot vs. Load Capacitance



Figure 34. Small-Signal Transient Response



Figure 35. Large-Signal Transient Response

04648-0-0331

### APPLICATIONS INPUT OVERVOLTAGE PROTECTION

The AD8615/AD8616/AD8618 have internal protective circuitry that allows voltages exceeding the supply to be applied at the input.

It is recommended, however, not to apply voltages that exceed the supplies by more than 1.5 V at either input of the amplifier. If a higher input voltage is applied, series resistors should be used to limit the current flowing into the inputs.

The input current should be limited to <5 mA. The extremely low input bias current allows the use of larger resistors, which allows the user to apply higher voltages at the inputs. The use of these resistors adds thermal noise, which contributes to the overall output voltage noise of the amplifier.

For example, a 10 k $\Omega$  resistor has less than 13 nV/ $\!\sqrt{Hz}$  of thermal noise and less than 10 nV of error voltage at room temperature.

### **OUTPUT PHASE REVERSAL**

The AD8615/AD8616/AD8618 are immune to phase inversion, a phenomenon that occurs when the voltage applied at the input of the amplifier exceeds the maximum input common mode.

Phase reversal can cause permanent damage to the amplifier and can create lock-ups in systems with feedback loops.



### **DRIVING CAPACITIVE LOADS**

Although the AD8615/AD8616/AD8618 are capable of driving capacitive loads of up to 500 pF without oscillating, a large amount of overshoot is present when operating at frequencies above 100 kHz. This is especially true when the amplifier is configured in positive unity gain (worst case). When such large capacitive loads are required, the use of external compensation is highly recommended.

This reduces the overshoot and minimizes ringing, which in turn improves the frequency response of the AD8615/ AD8616/AD8618. One simple technique for compensation is the snubber, which consists of a simple RC network. With this circuit in place, output swing is maintained and the amplifier is stable at all gains.

Figure 38 shows the implementation of the snubber, which reduces overshoot by more than 30% and eliminates ringing that can cause instability. Using the snubber does not recover the loss of bandwidth incurred from a heavy capacitive load.



Figure 37. Driving Heavy Capacitive Loads Without Compensation

4648-0-03



Figure 39. Driving Heavy Capacitive Loads Using the Snubber Network

### **OVERLOAD RECOVERY TIME**

Overload recovery time is the time it takes the output of the amplifier to come out of saturation and recover to its linear region. Overload recovery is particularly important in applications where small signals must be amplified in the presence of large transients. Figure 40 and Figure 41 show the positive and negative overload recovery times of the AD8616. In both cases, the time elapsed before the AD8616 comes out of saturation is less than 1  $\mu$ s. In addition, the symmetry between the positive and negative recovery times allows excellent signal rectification without distortion to the output signal.



### D/A CONVERSION

The AD8616 can be used at the output of high resolution DACs. Their low offset voltage, fast slew rate, and fast settling time make the parts suitable to buffer voltage output or current output DACs.

Figure 42 shows an example of the AD8616 at the output of the AD5542. The AD8616's rail-to-rail output and low distortion help maintain the accuracy needed in data acquisition systems and automated test equipment.



### Figure 42. Buffering DAC Output

### LOW NOISE APPLICATIONS

Although the AD8618 typically has less than 8 nV/ $\sqrt{Hz}$  of voltage noise density at 1 kHz, it is possible to reduce it further. A simple method is to connect the amplifiers in parallel, as shown in Figure 43. The total noise at the output is divided by the square root of the number of amplifiers. In this case, the total noise is approximately 4 nV/ $\sqrt{Hz}$  at room temperature. The 100  $\Omega$  resistor limits the current and provides an effective output resistance of 50  $\Omega$ .



Figure 43. Noise Reduction

### HIGH SPEED PHOTODIODE PREAMPLIFIER

The AD8615/AD8616/AD8618 are excellent choices for I-to-V conversions. The very low input bias, low current noise, and high unity-gain bandwidth of the parts make them suitable, especially for high speed photodiode preamps.

In high speed photodiode applications, the diode is operated in a photoconductive mode (reverse biased). This lowers the junction capacitance at the expense of an increase in the amount of dark current that flows out of the diode.

The total input capacitance, C1, is the sum of the diode and op amp input capacitances. This creates a feedback pole that causes degradation of the phase margin, making the op amp unstable. Therefore, it is necessary to use a capacitor in the feedback to compensate for this pole.

To get the maximum signal bandwidth, select

$$C2 = \sqrt{\frac{C1}{2\pi R^2 f_U}}$$

where  $f_U$  is the unity-gain bandwidth of the amplifier.



Figure 44. High Speed Photodiode Preamplifier

#### **ACTIVE FILTERS**

The low input-bias current and high unity-gain bandwidth of the AD8616 make it an excellent choice for precision filter design.

Figure 45 shows the implementation of a second-order, lowpass filter. The Butterworth response has a corner frequency of 100 kHz and a phase shift of 90°. The frequency response is shown in Figure 46.



Figure 45. Second-Order, Low-Pass Filter





### **POWER DISSIPATION**

Although the AD8615/AD8616/AD8618 are capable of providing load currents up to 150 mA, the usable output, load current, and drive capability is limited to the maximum power dissipation allowed by the device package.

In any application, the absolute maximum junction temperature for the AD8615/AD8616/AD8618 is 150°C. This should never be exceeded because the device could suffer premature failure. Accurately measuring power dissipation of an integrated circuit is not always a straightforward exercise; Figure 47 is a design aid for setting a safe output current drive level or selecting a heat sink for the package options available on the AD8616.



Figure 47. Maximum Power Dissipation vs. Ambient Temperature

These thermal resistance curves were determined using the AD8616 thermal resistance data for each package and a maximum junction temperature of 150°C. The following formula can be used to calculate the internal junction temperature of the AD8615/AD8616/AD8618 for any application:

 $T_J = P_{DISS} \times \theta_{JA} + T_A$ 

where:

 $T_J$  = junction temperature  $P_{DISS}$  = power dissipation  $\theta_{JA}$  = package thermal resistance, junction-to-case  $T_A$  = ambient temperature of the circuit

To calculate the power dissipated by the AD8615/ AD8616/AD8618, use

 $P_{DISS} = I_{LOAD} \times (V_S - V_{OUT})$ 

where:

 $I_{LOAD}$  = output load current  $V_S$  = supply voltage  $V_{OUT}$  = output voltage

The quantity within the parentheses is the maximum voltage developed across either output transistor.

# POWER CALCULATIONS FOR VARYING OR UNKNOWN LOADS

Often, calculating power dissipated by an integrated circuit to determine if the device is being operated in a safe range is not as simple as it might seem. In many cases, power cannot be directly measured. This may be the result of irregular output waveforms or varying loads. Indirect methods of measuring power are required.

There are two methods to calculate power dissipated by an integrated circuit. The first is to measure the package temperature and the board temperature. The second is to directly measure the circuits supply current.

### Calculating Power by Measuring Ambient and Case Temperature

The two equations for calculating junction temperature are

 $T_J = T_A + P \,\theta_{JA}$ 

where:

 $T_J$  = junction temperature  $T_A$  = ambient temperature  $\theta_{JA}$  = the junction-to-ambient thermal resistance

 $T_J = T_C + P \theta_{JC}$ 

where  $T_C$  is case temperature and  $\theta_{IA}$  and  $\theta_{IC}$  are given in the data sheet.

The two equations for calculating P (power) are

$$T_A + P \theta_{JA} = T_C + P \theta_{JC}$$
$$P = (T_A - T_C)/(\theta_{JC} - \theta_{JA})$$

Once power has been determined, it is necessary to recalculate the junction temperature to ensure that it has not been exceeded.

The temperature should be measured directly on and near the package, but not touching it. Measuring the package can be difficult. A very small bimetallic junction glued to the package can be used, or an infrared sensing device can be used if the spot size is small enough.

### Calculating Power by Measuring Supply Current

Power can be calculated directly if the supply voltage and current are known. However, the supply current can have a dc component with a pulse directed into a capacitive load, which could make the rms current very difficult to calculate. This difficulty can be overcome by lifting the supply pin and inserting an rms current meter into the circuit. For this method to work, make sure the current is delivered by the supply pin being measured. This is usually a good method in a singlesupply system; however, if the system uses dual supplies, both supplies may need to be monitored.

### **OUTLINE DIMENSIONS**



Figure 49. 8-Lead Standard Small Outline Package [SOIC] Narrow Body (R-8) Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MS-012-AB CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 50. 14-Lead Standard Small Outline Package [SOIC] Narrow Body (R-14) Dimensions shown in millimeters and (inches)



Figure 51. 14-Lead Thin Shrink Small Outline Package [TSSOP] (RU-14) Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-193-AB WITH THE EXCEPTION OF PACKAGE HEIGHT AND THICKNESS.

Figure 52. 5-Lead Thin Small Outline Transistor Package [TSOT] (UJ-5) Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
AD8615AUJZ-R21	-40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8615AUJZ-REEL <sup>1</sup>	-40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8615AUJZ-REEL71	-40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8616ARM-R2	-40°C to +125°C	8-Lead MSOP	RM-8	BLA
AD8616ARM-REEL	-40°C to +125°C	8-Lead MSOP	RM-8	BLA
AD8616ARMZ-R21	-40°C to +125°C	8-Lead MSOP	RM-8	A0K
AD8616ARMZ-REEL <sup>1</sup>	–40°C to +125°C	8-Lead MSOP	RM-8	AOK
AD8616AR	-40°C to +125°C	8-Lead SOIC	R-8	
AD8616AR-REEL	-40°C to +125°C	8-Lead SOIC	R-8	
AD8616AR-REEL7	–40°C to +125°C	8-Lead SOIC	R-8	
AD8616ARZ <sup>1</sup>	-40°C to +125°C	8-Lead SOIC	R-8	
AD8616ARZ-REEL <sup>1</sup>	–40°C to +125°C	8-Lead SOIC	R-8	
AD8616ARZ-REEL71	–40°C to +125°C	8-Lead SOIC	R-8	
AD8618AR	-40°C to +125°C	14-Lead SOIC	R-14	
AD8618AR-REEL	–40°C to +125°C	14-Lead SOIC	R-14	
AD8618AR-REEL7	-40°C to +125°C	14-Lead SOIC	R-14	
AD8618ARZ <sup>1</sup>	–40°C to +125°C	14-Lead SOIC	R-14	
AD8618ARZ-REEL <sup>1</sup>	–40°C to +125°C	14-Lead SOIC	R-14	
AD8618ARZ-REEL71	–40°C to +125°C	14-Lead SOIC	R-14	
AD8618ARU	–40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARU-REEL	–40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARUZ <sup>1</sup>	-40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARUZ-REEL <sup>1</sup>	–40°C to +125°C	14-Lead TSSOP	RU-14	

 $^{1}$  Z = Pb-free part.

# NOTES

# NOTES

## NOTES



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